



CERAMIC

Bandpass Filter

BFHK-1272+

50Ω 11.9 to 12.8 GHz

THE BIG DEAL

- Ultra-High Stopband Rejection Structure – 100 dB typical
- Surface mountable pick and place standard case style
- Standard small 1812 (4.5mm x 3.2mm) case style
- High quality distributed filter topology
- Wide rejection band
- Shielded construction preventing filter from de-tuning
- Reduced footprint area by employing LGA (land grid array)
- Suited for very high-volume production
- Protected by US Patents 11,638,370 and 11,744,057



Generic photo used for illustration purposes only

CASE STYLE: NM1812C-3

+RoHS Compliant

The +Suffix identifies RoHS Compliance. See our website for methodologies and qualifications

APPLICATIONS

- Test and Measurement
- Aerospace and Defense Signal Conditioning

PRODUCT OVERVIEW

The BFHK-1272+ LTCC Band Pass Filter achieves a miniature size and high repeatability of performance by utilizing a proprietary LTCC material system and distributed filter topology. The passband loss at 11.9 – 12.8 GHz is as low as 2.9 dB, with typical stopband rejections at 100 dB up to 31 GHz. This model handles up to 1W RF input power, and provides a wide operating temperature range from -55 to +125°C. Utilizing a proprietary LTCC material system and a distributed filter topology, this filter is able to achieve repeatable performance on a lot-to-lot basis, up to mmWave frequencies.

KEY FEATURES

Feature	Advantages
Ultra-High Rejection	Typical stopband rejections at 100 dB up to 31 GHz
Cost effective	LTCC is scalable technology that is cost effective due to ease of production in high quantities.
Small size (4.5mm x 3.2mm)	Allows for high layout density of circuit boards, while minimizing effects of parasitics.
Surface Mountable	Suitable for very high volume automated assembly process.

REV. A
ECO-019695
BFHK-1272+
WY/CP/PS
231102





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ELECTRICAL SPECIFICATIONS¹ AT 25°C

Parameter	F#	Frequency (GHz)	Min.	Typ.	Max.	Units	
Pass Band	Center Frequency	—	—	12.3	—	GHz	
	Insertion Loss	F1-F2	11.9 - 12.8	—	2.9	4.5	dB
	Return Loss	F1-F2	11.9 - 12.8	—	10	—	dB
Stop Band, Lower	Insertion Loss	DC-F3	2.0 - 8.6	70	80	—	dB
Stop Band, Upper	Insertion Loss	F4-F5	16.7 - 18	70	90	—	dB
			18 - 31	80	100	—	
			31 - 38	55	70	—	

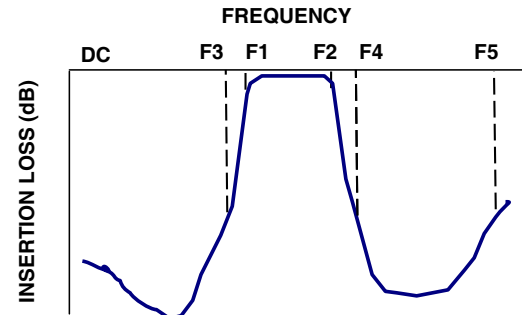
1. Measured on Mini-Circuits Test Board TB-BFHK-1272C+ with feedline losses removed by normalization of S12 and S21 traces to measurement of TB thru-line

MAXIMUM RATINGS

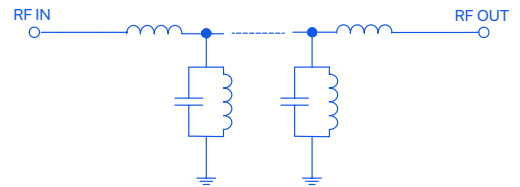
Parameter	Ratings
Operating Temperature	-55°C to 125°C
Storage Temperature	-55°C to 125°C
RF Power Input	1W max.

Permanent damage may occur if any of these limits are exceeded

TYPICAL FREQUENCY RESPONSE



FUNCTIONAL SCHEMATIC



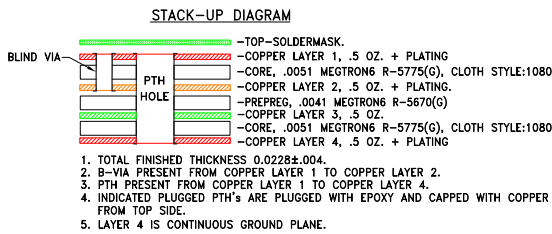
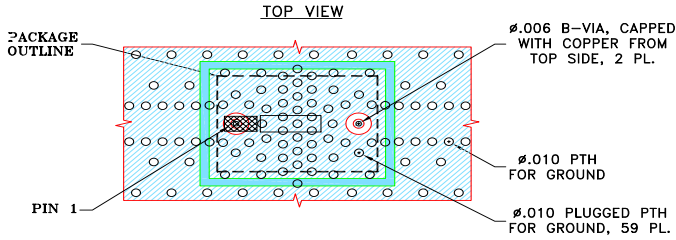


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EVALUATION BOARD MCL P/N: TB-BFHK-1272C+ SUGGESTED PCB LAYOUT: PL-730

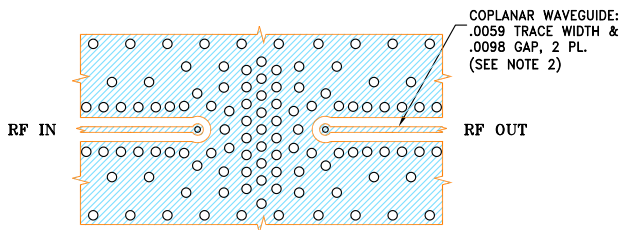


NOTES:

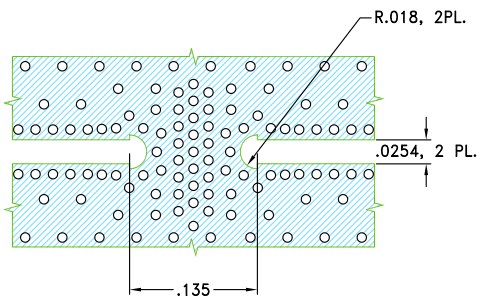
- PCB IS MULTILAYER PCB, SEE STACK-UP DIAGRAM.
- TRACE WIDTH & GAP PARAMETERS ARE SHOWN FOR MEGTRON6 R-5775(G), CLOTH STYLE:1080 WITH DIELECTRIC THICKNESS .0051; COPPER: 1/2 OZ.+PLATING. FOR OTHER MATERIALS TRACE WIDTH AND GAP MAY NEED TO BE MODIFIED.
- COPPER LAYER 4 OF THE PCB ARE CONTINUOUS GROUND PLANE.

- DENOTES PCB COPPER LAYOUT WITH SMOBC (SOLDER MASK OVER BARE COPPER)
- DENOTES COPPER LAND PATTERN FREE OF SOLDER MASK

LAYER 2, B-VIA & PTH



LAYER 3 & PTH

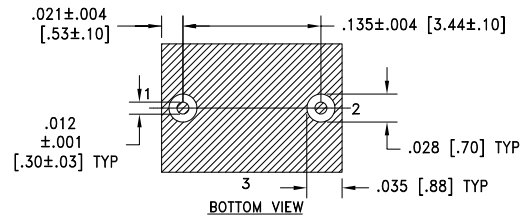
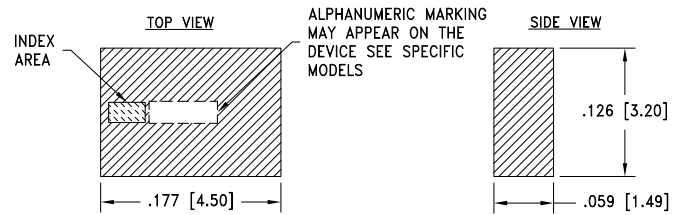


PAD CONNECTIONS

INPUT	1
OUTPUT	2
GROUND	3

PRODUCT MARKING: F443

OUTLINE DRAWING



Weight: .126 grams.

Dimensions are in inches (mm). Tolerances: 2 Pl.±.01; 3 Pl. ±.005



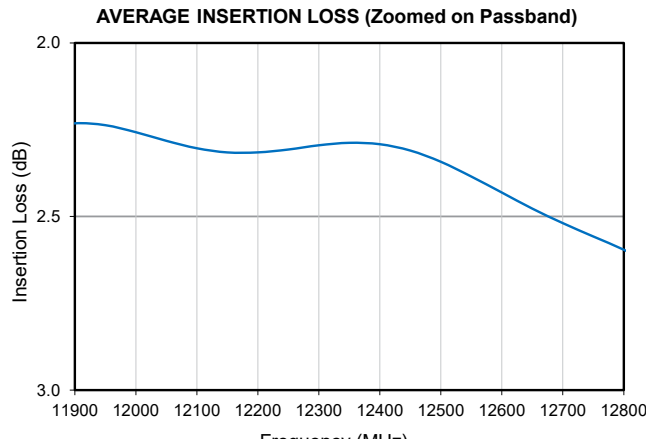
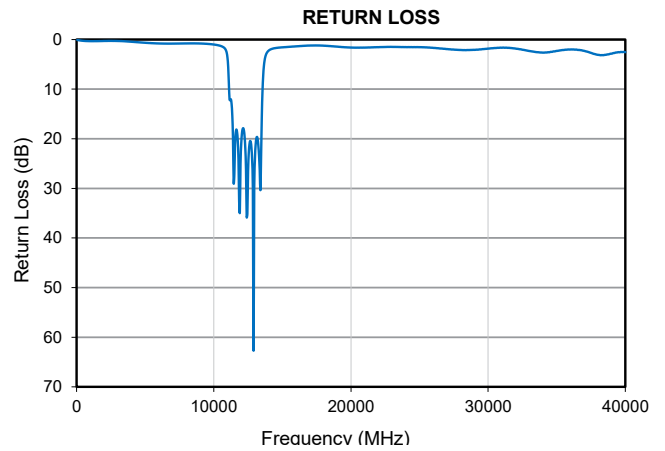
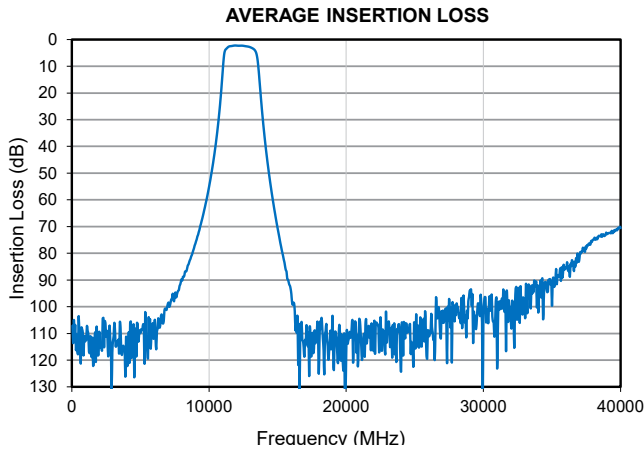
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TYPICAL PERFORMANCE DATA

Frequency (MHz)	Insertion Loss (dB)	Return Loss (dB)
50	107.12	0.07
1500	111.56	0.32
2000	109.36	0.28
4500	106.56	0.55
6000	109.36	0.79
7500	95.84	0.80
8600	82.61	0.78
10500	38.71	1.29
11900	2.23	34.79
12300	2.29	22.04
12800	2.60	24.54
15000	70.66	1.57
16700	106.57	1.25
18000	125.11	1.24
20000	117.63	1.61



- NOTES**
- A. Performance and quality attributes and conditions not expressly stated in this specification document are intended to be excluded and do not form a part of this specification document.
 - B. Electrical specifications and performance data contained in this specification document are based on Mini-Circuit's applicable established test performance criteria and measurement instructions.
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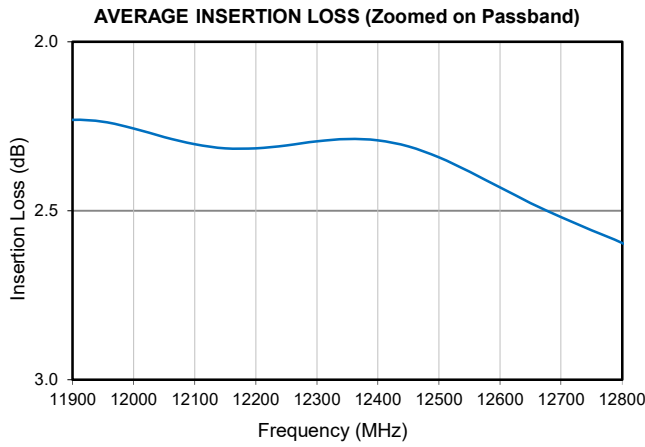
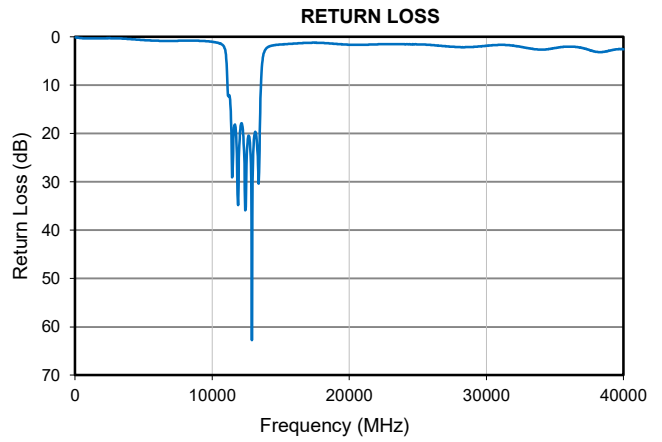
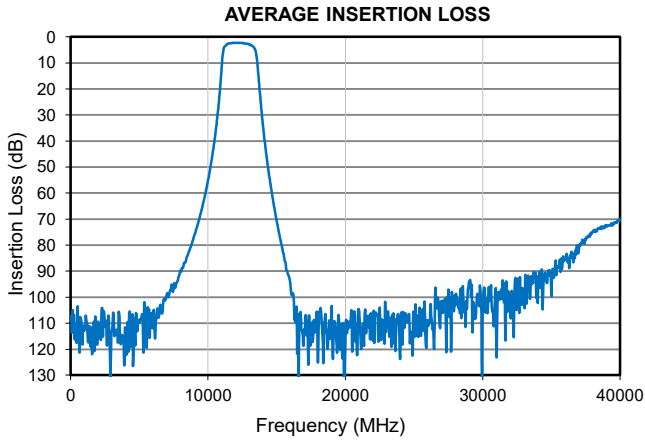
LTCC Bandpass Filter

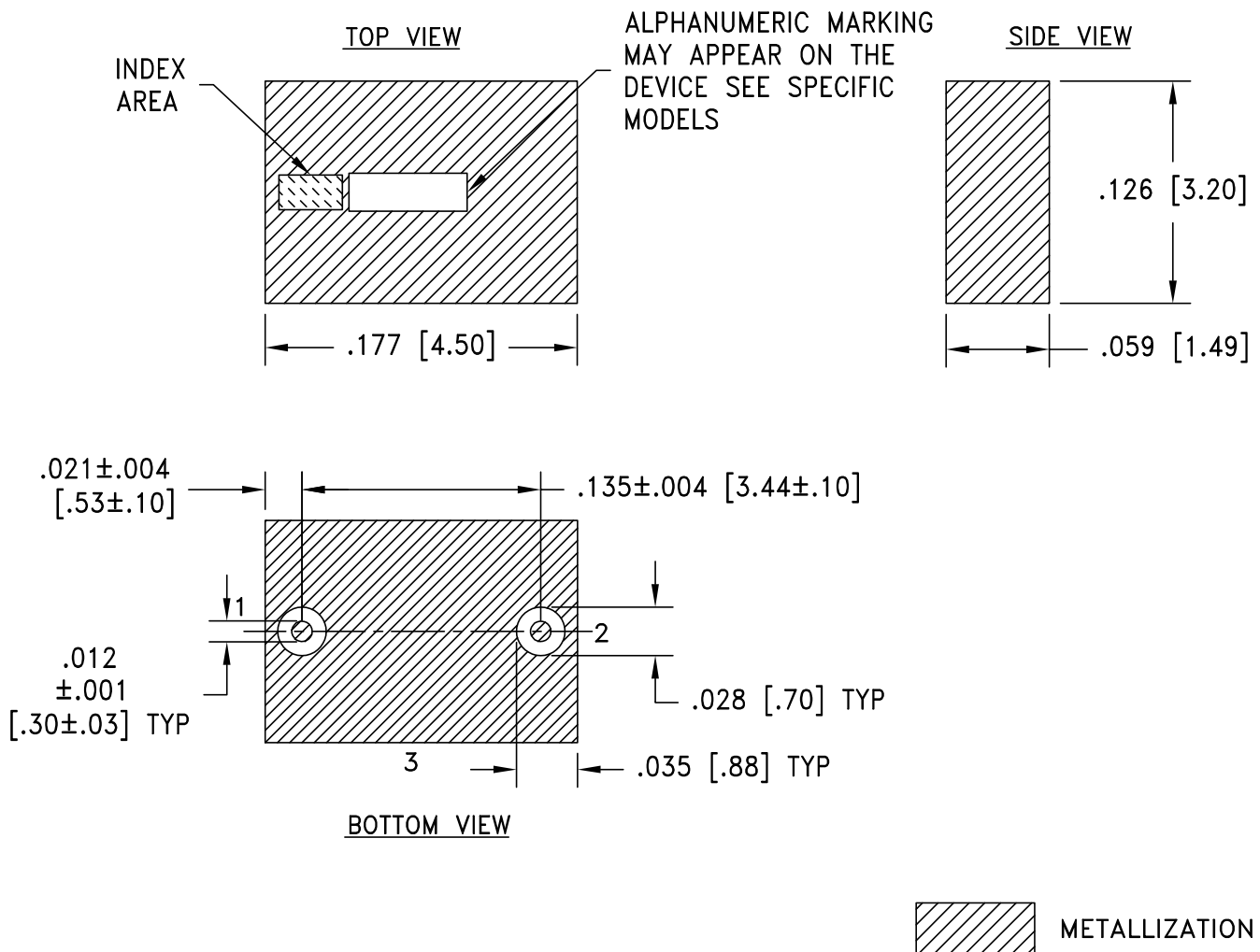
BFHK-1272+

Typical Performance Data

FREQUENCY (MHz)	INSERTION LOSS (dB)	RETURN LOSS (dB)
50	107.12	0.07
100	113.65	0.11
500	103.52	0.26
1000	112.58	0.32
1500	111.56	0.32
2000	109.36	0.28
2500	111.28	0.27
3000	112.84	0.29
3500	105.85	0.35
4000	115.86	0.44
4500	106.56	0.55
5000	109.91	0.65
5500	116.29	0.73
6000	109.36	0.79
6500	103.42	0.82
7000	98.93	0.82
7500	95.84	0.80
8000	89.68	0.78
8600	82.61	0.78
9000	76.46	0.80
9500	67.14	0.86
10000	55.17	1.00
10500	38.71	1.29
11000	11.53	3.67
11500	2.52	27.17
11550	2.48	21.12
11600	2.45	18.74
11650	2.42	18.12
11700	2.38	18.69
11900	2.23	34.79
11950	2.24	25.10
12000	2.26	21.09
12050	2.28	19.03
12100	2.30	18.07
12150	2.32	17.86
12200	2.32	18.35
12250	2.31	19.68
12300	2.29	22.04
12350	2.29	26.20
12400	2.29	35.79
12450	2.31	35.09
12500	2.34	26.52
12550	2.38	22.97
12600	2.43	21.14
12650	2.48	20.44
12700	2.52	20.68
12750	2.56	21.93
12800	2.60	24.54
13000	2.87	24.09
13500	6.36	15.65
14000	34.03	2.23
14500	54.96	1.72
15000	70.66	1.57
16000	95.24	1.37
16700	106.57	1.25
18000	125.11	1.24
20000	117.63	1.61
22000	116.61	1.54
24000	123.81	1.52
26000	109.70	1.68
28000	103.21	2.10
30000	103.02	1.83
32000	105.22	1.82
34000	102.21	2.64
36000	85.24	2.00
38000	74.89	3.08
40000	70.56	2.53

Typical Performance Data





Weight: .126 grams.

Dimensions are in inches [mm]. Tolerances: 2 Pl. ±.01; 3 Pl. ±.005 Inches

Notes:

1. Case material: Ceramic.
2. Termination Finish: **as shown below or indicated on Data Sheet.**
For RoHS Case Styles: Tin Plate over Nickel plate. All models, (+) suffix.

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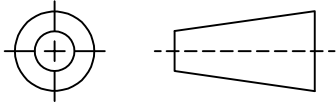
P.O. Box 350166, Brooklyn, New York 11235-0003 (718) 934-4500 Fax (718) 332-4661 For detailed performance specs & shopping online see Mini-Circuits web site



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RF/IF MICROWAVE COMPONENTS

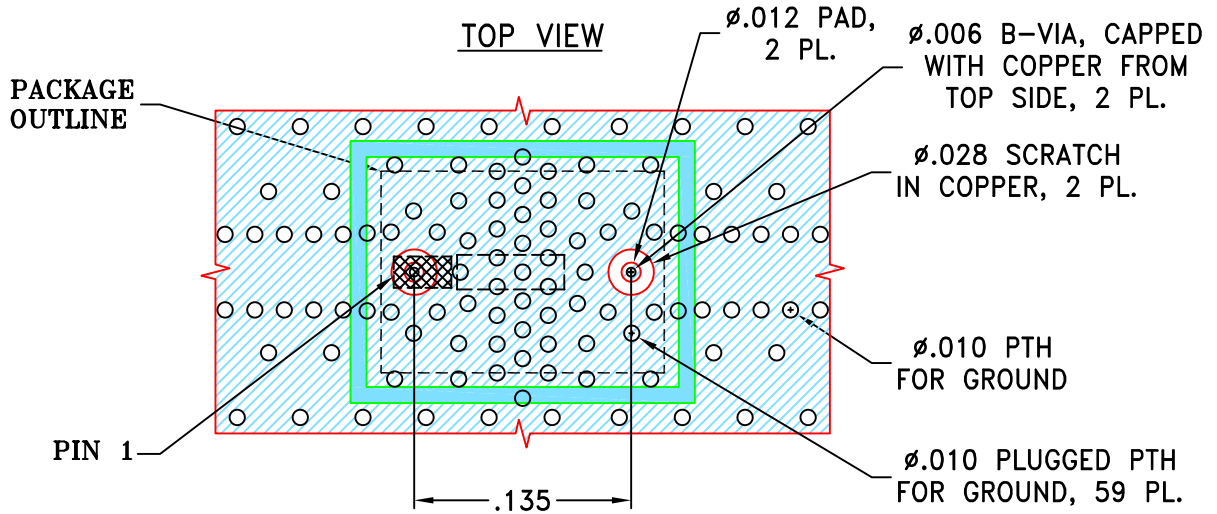
THIRD ANGLE PROJECTION



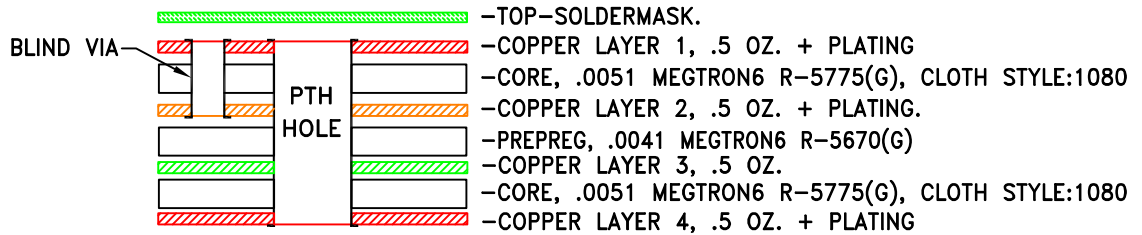
REVISIONS

REV	ECN No.	DESCRIPTION	DATE	DR	AUTH
OR	ECO-013254	NEW RELEASE	05/16/22	ITG	IL
A	ECO-015587	UPDATED STACK-UP DIAGRAM	11/01/22	ITG	IL
B	ECO-020890	ADDED DIMENSIONS	02/16/24	ITG	IL

SUGGESTED MOUNTING CONFIGURATION FOR
NM1812C-3 CASE STYLE



STACK-UP DIAGRAM



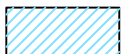
1. TOTAL FINISHED THICKNESS 0.0228±.004.
2. B-VIA PRESENT FROM COPPER LAYER 1 TO COPPER LAYER 2.
3. PTH PRESENT FROM COPPER LAYER 1 TO COPPER LAYER 4.
4. INDICATED PLUGGED PTH'S ARE PLUGGED WITH EPOXY AND CAPPED WITH COPPER FROM TOP SIDE.
5. LAYER 4 IS CONTINUOUS GROUND PLANE.

NOTES:

1. PCB IS MULTILAYER PCB, SEE STACK-UP DIAGRAM.
2. TRACE WIDTH & GAP PARAMETERS ARE SHOWN FOR MEGTRON6 R-5775(G), CLOTH STYLE:1080 WITH DIELECTRIC THICKNESS .0051; COPPER: 1/2 OZ.+PLATING. FOR OTHER MATERIALS TRACE WIDTH AND GAP MAY NEED TO BE MODIFIED.
3. COPPER LAYER 4 OF THE PCB ARE CONTINUOUS GROUND PLANE.



DENOTES PCB COPPER LAYOUT WITH SMOBC (SOLDER MASK OVER BARE COPPER)



DENOTES COPPER LAND PATTERN FREE OF SOLDER MASK

UNLESS OTHERWISE SPECIFIED	INITIALS		DATE
DIMENSIONS ARE IN INCHES TOLERANCES ON: 2 PL DECIMALS ± 3 PL DECIMALS ± .005 ANGLES ± FRACTIONS ±	DRAWN	ITG	05/16/22
	CHECKED	GF	05/16/22
	APPROVED	IL	05/16/22



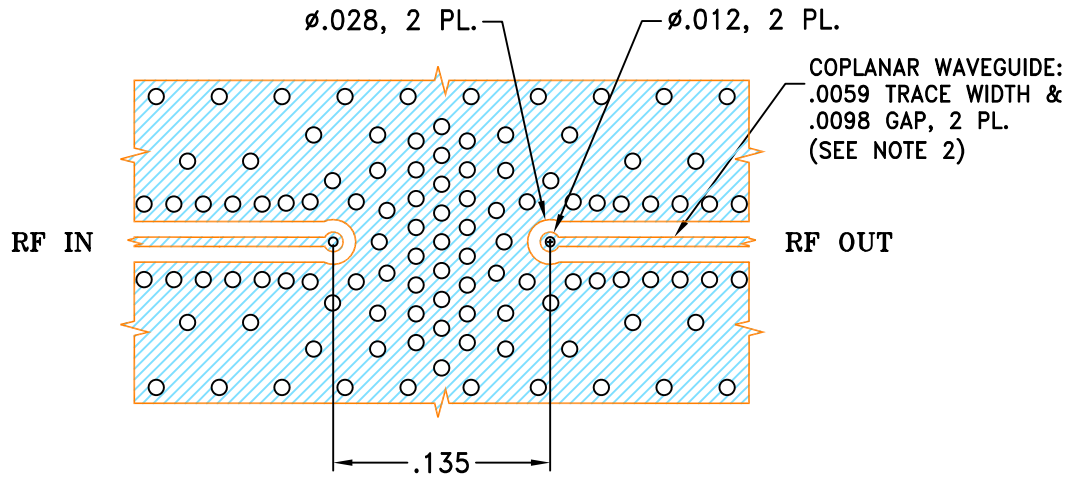
Mini-Circuits® 13 Neptune Avenue
Brooklyn NY 11235

PL, NM1812C-3, TB-1239

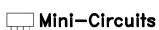
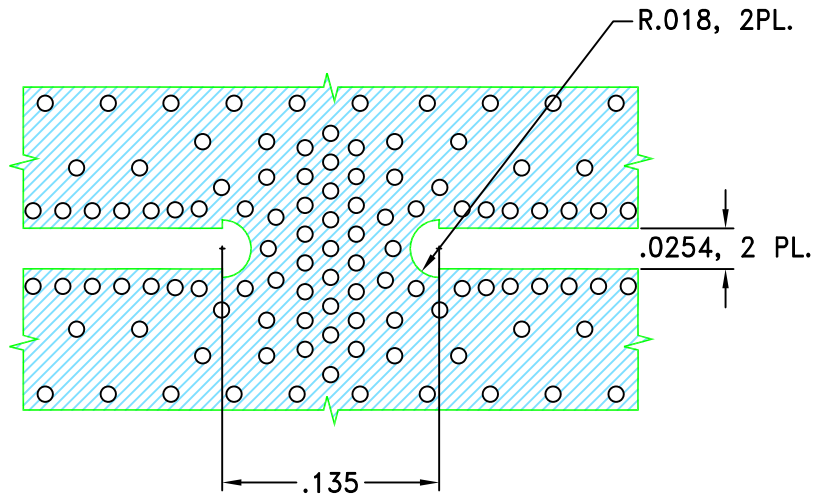
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SIZE	CODE IDENT	DRAWING NO:	REV:
A	15542	98-PL-730	B
FILE:	98PL730	SCALE: 8:1	SHEET: 1 OF 2

LAYER 2, B-VIA & PTH



LAYER 3 & PTH

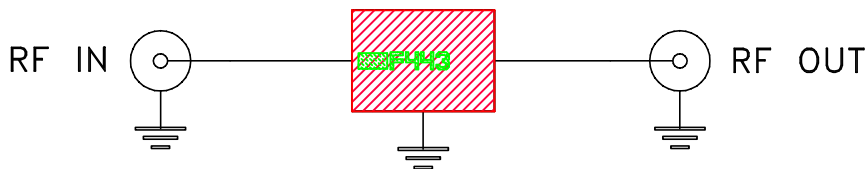
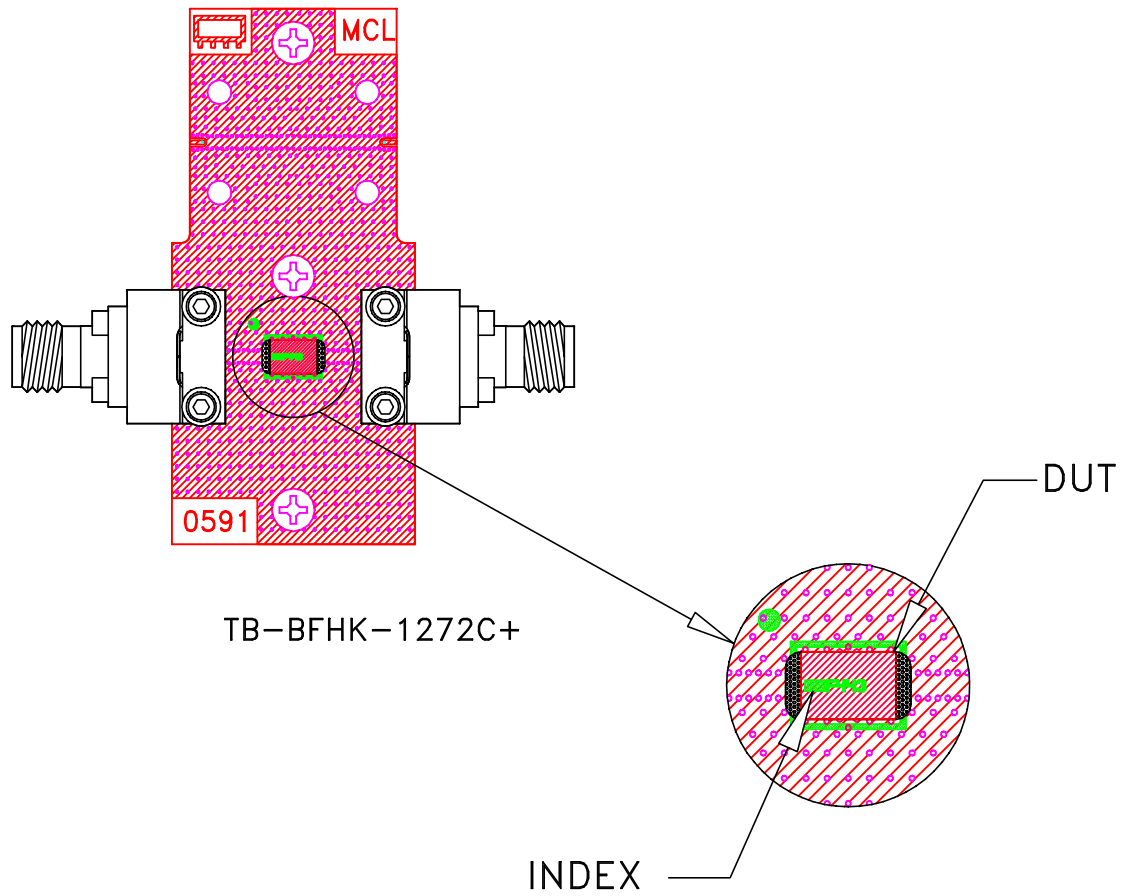


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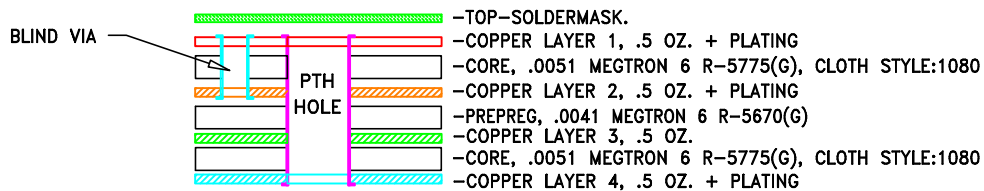
ALL DIMENSIONS ARE IN INCHES EXCEPT OTHERWISE SPECIFIED

SIZE A	CODE IDENT 15542	DRAWING NO: 98-PL-730	REV: B
FILE: 98PL730	SCALE: 8:1	SHEET: 2 OF 2	

Evaluation Board and Circuit




Schematic Diagram



STACK-UP DIAGRAM

Notes:

1. 2.92 mm Female End Launch Connector.
2. PCB Material: Megtron 6 R5775(N).
Dielectric Constant=3.6.
3. Total finished thickness .023".

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All Mini-Circuits products are manufactured under exacting quality assurance and control standards, and are capable of meeting published specifications after being subjected to any or all of the following physical and environmental test.

Specification	Test/Inspection Condition	Reference/Spec
Operating Temperature	-55° to 125° C Ambient Environment	Individual Model Data Sheet
Storage Temperature	-55° to 125° C Ambient Environment	Individual Model Data Sheet
Thermal Cycling	-55 to 125°C, 100 cycles, Dwell Time 15 minutes.	MIL-STD-202, Method 107, Condition A-3
Mechanical Shock	50g, 11ms half-sine, 18 shocks applied each to 3 axes	MIL-STD-202 Method 213, Condition A
Vibration	10-2000Hz sine, 20g, 12 cycles applied each to 3 axes	MIL-STD-202, Method 204, Condition D
Constant Acceleration	30Kg, Y1 Direction	MIL-STD-883, Method 2001, Condition E
Humidity	85°C, 90-95% Relative Humidity, 250hours	
Solderability	10X / 30X Magnification	J-STD-002C Test S, J-STD-002C Test S1
High Temp Storage	125°C, 250 hours	